

MOSFET - N-Channel, QFET

900 V, 7.0 A, 1.1 Ω

FQAF11N90C

Description

This N-Channel enhancement mode power MOSFET is produced using **onsemi**'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- 7.0 A, 900 V, $R_{DS(on)} = 1.1 \Omega$ (Max.) @ $V_{GS} = 10 \text{ V}$, $I_D = 3.5 \text{ A}$
- Low Gate Charge (Typ. 60 nC)
- Low C_{rss} (Typ. 23 pF)
- 100% Avalanche Tested
- This is a Pb-Free Device

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

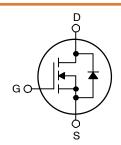
Symbol	Parameter	Value	Unit
V _{DSS}	Drain-Source Voltage	900	V
I _D	$ \begin{array}{ll} \text{Drain Current} & -\text{ Continuous } (T_C = 25^{\circ}\text{C}) \\ & -\text{ Continuous } (T_C = 100^{\circ}\text{C}) \end{array} $	7.0 4.4	A A
I _{DM}	Drain Current - Pulsed (Note 1)	28.0	Α
V _{GSS}	Gate-Source Voltage	±30	V
E _{AS}	Single Pulsed Avalanche Energy (Note 2)	960	mJ
I _{AR}	Avalanche Current (Note 1)	7.0	Α
E _{AR}	Repetitive Avalanche Energy (Note 1)	12	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	4.0	V/ns
P _D	Power Dissipation (T _C = 25°C) - Derate Above 25°C	120 0.96	W W/°C
T _J , T _{STG}	Operating and Storage Temperature Range	–55 to +150	°C
TL	Maximum Lead Temperature for Soldering Purposes, 1/8" from Case for 5 seconds	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. L = 37 mH, I_{AS} = 7.0 A, V_{DD} = 50 V, R_G = 25 Ω , Starting T_J = 25 $^{\circ}$ C.
- 3. $I_{SD} \le 11.0$ A, di/dt ≤ 200 A/ μ s, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25$ °C.

V _{DSS}	R _{DS(on)} MAX	I _D MAX
900 V	1.1 Ω @ 10 V	7.0 A



N-CHANNEL MOSFET



MARKING DIAGRAM

FQAF 11N90C AYWWZZ

FQAF11N90 = Specific Device Code
A = Assembly Plant Code
YWW = Date Code (Year & Week)
ZZ = Lot Code

ORDERING INFORMATION

Device	Package	Shipping
FQAF11N90C	TO-3PF (Pb-Free)	30 Units / Tube

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{ heta JC}$	Thermal Resistance, Junction-to-Case, Max.	1.04	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	40	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS	•	•		•	•
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A},$	900	_	_	V
$\Delta BV_{DSS} \ / \Delta T_{J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C	-	1.00	_	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 900 V, V _{GS} = 0 V	_	_	10	μΑ
		V _{DS} = 720 V, T _C = 125°C	_	_	100	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V	_	_	100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	-100	nA
ON CHARA	CTERISTICS	•				
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	3.0	_	5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 3.5 A	_	0.91	1.1	Ω
9FS	Forward Transconductance	V _{DS} = 50 V, I _D = 3.5 A	_	<u> </u>	-	S
DYNAMIC C	HARACTERISTICS		•		•	•
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	_	2530	3290	pF
C _{oss}	Output Capacitance	1	_	215	280	pF
C _{rss}	Reverse Transfer Capacitance	1	_	23	30	pF
SWITCHING	CHARACTERISTICS	•				
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 450 \text{ V}, I_D = 11.0 \text{ A}, R_G = 25 \Omega \text{ (Note 4)}$	_	60	130	ns
t _r	Turn-On Rise Time		_	130	270	ns
t _{d(off)}	Turn-Off Delay Time	1	_	130	270	ns
t _f	Turn-Off Fall Time	1	_	85	180	ns
Qg	Total Gate Charge	V _{DS} = 720 V, I _D = 11.0 A,	-	60	80	nC
Q_{gs}	Gate-Source Charge	V _{GS} = 10 V (Note 4)	=	13	-	nC
Q _{gd}	Gate-Drain Charge	1	_	25	-	nC
DRAIN-SOU	RCE DIODE CHARACTERISTICS AND N	IAXIMUM RATINGS				
I _S	Maximum Continuous Drain-Source Diode Forward Current		-	_	7.0	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		-	_	28.0	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 7.0 A	-	_	1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 11.0 A,	-	1000	-	ns
Q _{rr}	Reverse Recovery Charge	$dI_F/dt = 100 A/\mu s$	_	17.0	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially Independent of Operating Temperature.

TYPICAL CHARACTERISTICS

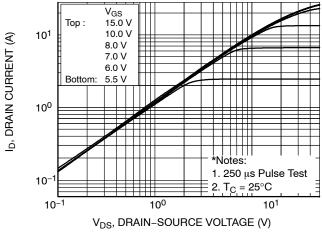


Figure 1. On-Region Characteristics

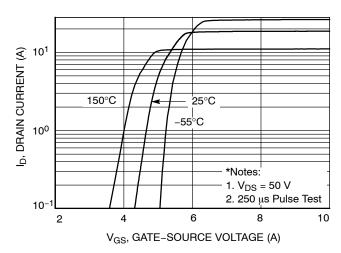


Figure 2. Transfer Characteristics

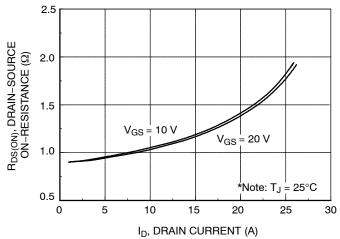


Figure 3. On-Resistance Variation vs. Drain **Current and Gate Voltage**

 $C_{oss} = C_{ds} + C_{qd}$

 $C_{rss} = C_{gd}$

4500

4000

3500

3000

2500

2000

1500

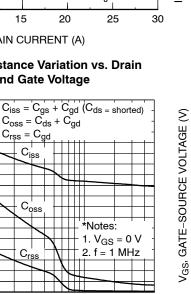
1000

500

0

 10^{-1}

CAPACITANCES (pF)



*Notes:

10¹

V_{SD}, DRAIN-SOURCE VOLTAGE (V) Figure 5. Capacitance Characteristics

Crss

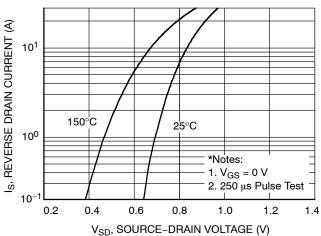


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

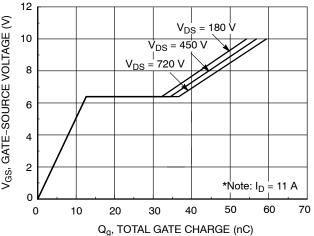


Figure 6. Gate Charge Characteristics

TYPICAL CHARACTERISTICS (CONTINUED)

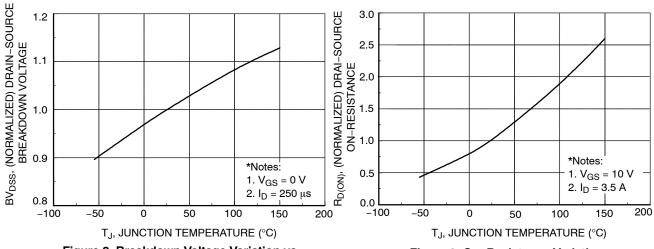


Figure 8. Breakdown Voltage Variation vs. Temperature

Figure 9. On–Resistance Variation vs. Temperature

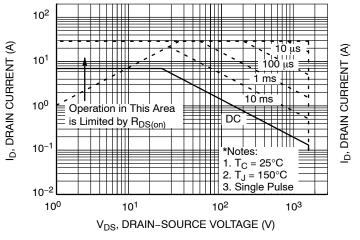


Figure 10. Maximum Safe Operating Area

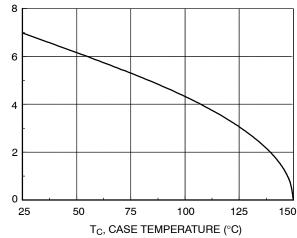


Figure 11. Maximum Drain Current vs. Case Temperature

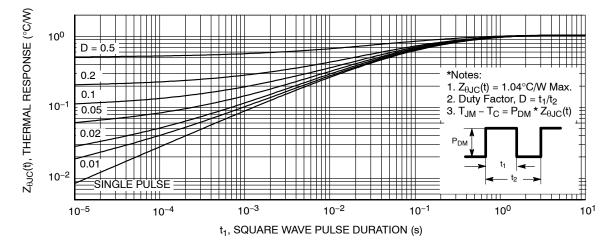


Figure 7. Transient Thermal Response Curve

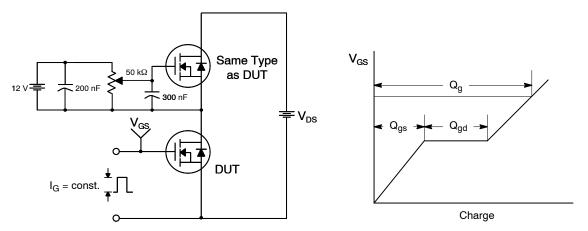


Figure 12. Gate Charge Test Circuit & Waveform

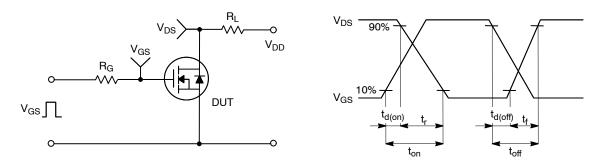


Figure 13. Resistive Switching Test Circuit & Waveforms

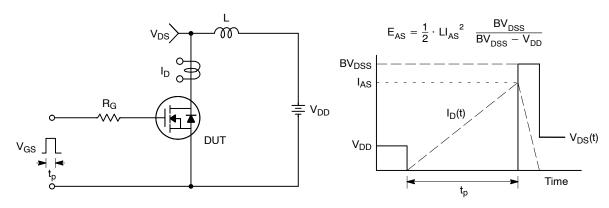


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

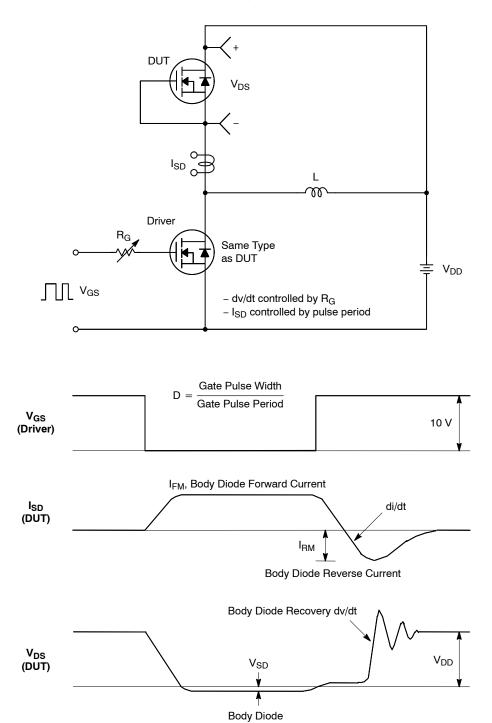


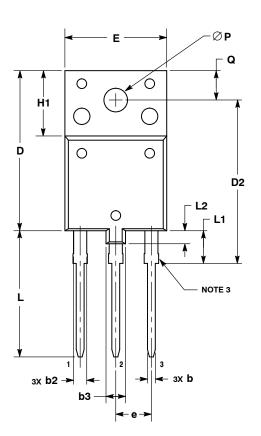
Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

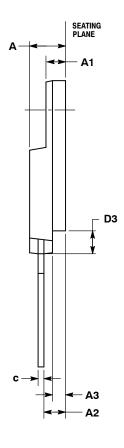
Forward Voltage Drop



TO-3PF-3L CASE 340AH **ISSUE A**

DATE 09 JAN 2015





- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
 2. CONTROLLING DIMENSION: MILLIMETERS.

- 2. CONTOUR UNCONTROLLED IN THIS AREA (6 PLACES).

 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR GATE PROTRUSIONS. MOLD FLASH AND GATE PROTRUSIONS. MOLD FLASH AND GATE PROTRUSIONS NOT TO EXCEED 0.13 PER SIDE. THES DIMENSIONS ARE TO BE MEASURED AT THE OUTERMOST EXTREME OF THE PLASTIC BODY.

 5. DIMENSION b2 DOES NOT INCLUDE DAMBAR PROTRUSION.
- LEAD WIDTH INCLUDING PROTRUSION SHALL NOT EXCEED 2.20.

	MILLIMETERS			
DIM	MIN	MAX		
Α	5.30	5.70		
A1	2.80	3.20		
A2	3.10	3.50		
А3	1.80	2.20		
p	0.65	0.95		
b2	1.90	2.15		
b3	3.80	4.20		
С	0.80	1.10		
D	24.30	24.70		
D2	24.70	25.30		
D3	3.30	3.70		
Е	15.30	15.70		
е	5.35	5.55		
H1	9.80	10.20		
Г	19.10	19.50		
L1	4.80	5.20		
L2	1.90	2.20		
Р	3.40	3.80		
Ø	4.30	4.70		

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